AM26LS31C, AM26LS31M QUADRUPLE DIFFERENTIAL LINE DRIVER

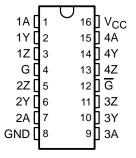
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- Meets or Exceeds the Requirements of ANSI TIA/EIA-422-B and ITU Recommendation V.11
- Operates From a Single 5-V Supply
- TTL Compatible
- Complementary Outputs
- High Output Impedance in Power-Off Conditions
- Complementary Output-Enable Inputs

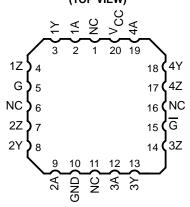
description/ordering information

AM26LS31 The is а quadruple complementary-output line driver designed to meet the requirements of ANSI TIA/EIA-422-B and ITU (formerly CCITT) Recommendation V.11. The 3-state outputs have high-current capability for driving balanced lines such as twisted-pair or parallel-wire transmission lines, and they are in the high-impedance state in the power-off condition. The enable function is common to all four drivers and offers the choice of an active-high or active-low enable (G, \overline{G}) input. Low-power Schottky circuitry reduces power consumption without sacrificing speed.

D, DB, N, NS, OR J PACKAGE (TOP VIEW)



FK PACKAGE (TOP VIEW)



ORDERING INFORMATION

TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube	AM26LS31CN	AM26LS31CN
	SOIC - D	Tube	AM26LS31CD	AM26LS31C
0°C to 70°C	3010 - D	Tape and reel	AM26LS31CDR	AMZOLSSTO
	SOP - NS	Tape and reel	AM26LS31CNSR	26LS31
	SSOP – DB	Tape and reel	AM26LS31CDBR	SA31C
-55°C to 125°C	CDIP – J	Tube	AM26LS31MJ	AM26LS31MJB
	LCCC - FK	Tube	AM26LS31MFK	AM26LS31MFKB

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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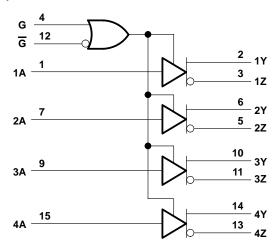
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FUNCTION TABLE (each driver)

INPUT	ENA	BLES	OUTPUTS		
Α	G	G	Y	Z	
Н	Н	Х	Н	L	
L	Н	X	L	Н	
Н	Х	L	Н	L	
L	Х	L	L	Н	
Х	L	Н	Z	Z	

H = high level, L = low level, X = irrelevant, Z = high impedance (off)

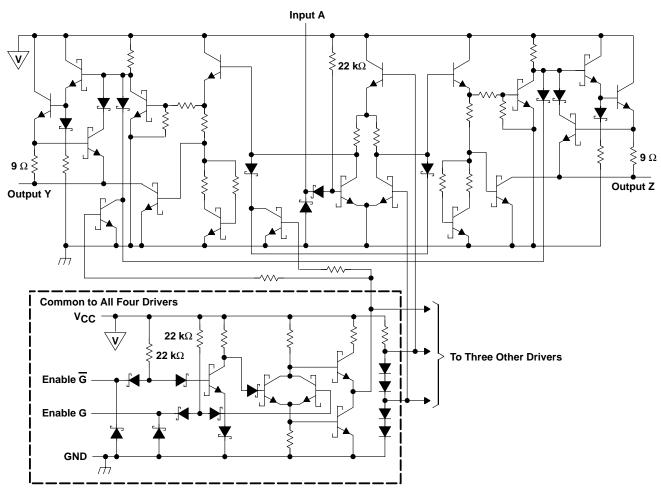
logic diagram (positive logic)



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schematic (each driver)



All resistor values are nominal.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)		7 V
Input voltage, V _I		
Output off-state voltage		5.5 V
Package thermal impedance, θ _{JA} (see Note 2)): D package	
•	DB package	82°C/W
	N package	67°C/W
	NS package	64°C/W
Lead temperature 1,6 mm (1/16 inch) from cas	se for 10 seconds	260°C
Lead temperature 1,6 mm (1/16 inch) from cas	se for 60 seconds: J package .	300°C
Storage temperature range, T _{stg}		–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential output voltage VOD, are with respect to network GND.

DISSIPATION RATING TABLE

$\begin{array}{c} \text{PACKAGE} & \text{$T_A \leq 25^{\circ}$C} \\ \text{POWER RATING} \end{array}$		DERATING FACTOR ABOVE T _A = 25°C [‡]	T _A = 70°C POWER RATING	T _A = 125°C POWER RATING	
FK	1375 mW	11.0 mW/°C	880 mW	275 mW	
J	1375 mW	11.0 mW/°C	880 mW	275 mW	

[‡] This is the inverse of the traditional junction-to-ambient thermal resistance (RθJA). Thermal resistances are not production tested and the values given are for informational purposes only.

recommended operating conditions

			MIN	NOM	MAX	UNIT
Mari	Cumbuvoltage	AM26LS31C	4.75	5	5.25	-l ∨ I
Vcc	Supply voltage	AM26LS31M	4.5	5	5.5	
VIH	V _{IH} High-level input voltage		2			V
٧ _{IL}	V _{IL} Low-level input voltage				8.0	V
lOH	I _{OH} High-level output current				-20	mA
lOL	I _{OL} Low-level output current				20	mA
т.	Operating free circumposeture	AM26LS31C	0		70	°C
TA	Operating free-air temperature	AM26LS31M	- 55		125	

^{2.} The package thermal impedance is calculated in accordance with JESD 51-7.

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electrical characteristics over operating free-air temperature range (unless otherwise noted)†

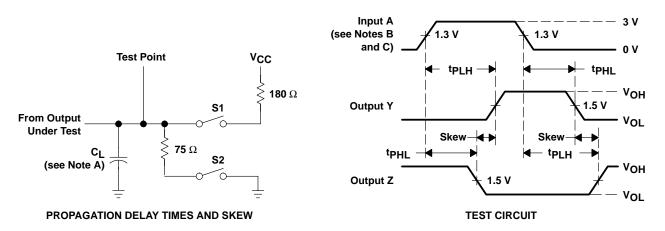
PARAMETER		TEST CONDITIONS		MIN	TYP‡	MAX	UNIT
٧ıK	Input clamp voltage	$V_{CC} = MIN,$	I _I = -18 mA			-1.5	V
Vari	High level output voltage	V _{CC} = MIN,	$T_A = -55^{\circ}C$	2.4			V
VOH	High-level output voltage	$I_{OH} = -20 \text{ mA}$	All other temperatures	2.5			V
VOL	Low-level output voltage	$V_{CC} = MIN,$	$I_{OL} = 20 \text{ mA}$			0.5	V
la-	Off state (high impedance state) output ourrent	Voc - MIN	$V_0 = 0.5 V$			-20	
loz	Off-state (high-impedance-state) output current	VCC = MIN	V _O = 2.5 V			20	μΑ
IĮ	Input current at maximum input voltage	$V_{CC} = MAX$,	V _I = 7 V			0.1	mA
lн	High-level input current	$V_{CC} = MAX$,	V _I = 2.7 V			20	μΑ
Ι _Ι L	Low-level input current	$V_{CC} = MAX$,	V _I = 0.4 V			-0.36	mA
los	Short-circuit output current§	V _{CC} = MAX		-30		-150	mA
Icc	Supply current	V _{CC} = MAX,	All outputs disabled		32	80	mA

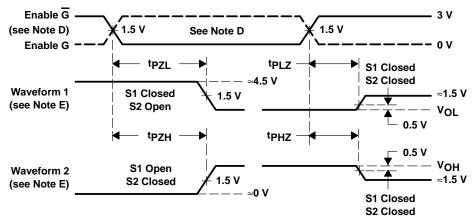
[†] For C suffix devices, V_{CC} MIN = 4.75 V and V_{CC} MAX = 5.25 V. For M suffix devices, V_{CC} MIN = 4.5 V and V_{CC} MAX = 5.5 V. ‡ All typical values are at V_{CC} = 5 V and T_A = 25°C. § Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see Figure 1)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
tPLH	Propagation delay time, low-to-high-level output	C _L = 30 pF,	S1 and S2 open		14	20	no
tPHL	Propagation delay time, high-to-low-level output				14	20	ns
tPZH	Output enable time to high level	C 20 pE	$R_L = 75 \Omega$		25	40	no
tPZL	Output enable time to low level	C _L = 30 pF	$R_L = 180 \Omega$		37	45	ns
tPHZ	Output disable time from high level	C _L = 10 pF,	_ = 10 pF, S1 and S2 closed		21	30	no
tPLZ	Output disable time from low level				23	35	ns
	Output-to-output skew	C _L = 30 pF,	S1 and S2 open		1	6	ns

PARAMETER MEASUREMENT INFORMATION





ENABLE AND DISABLE TIME WAVEFORMS

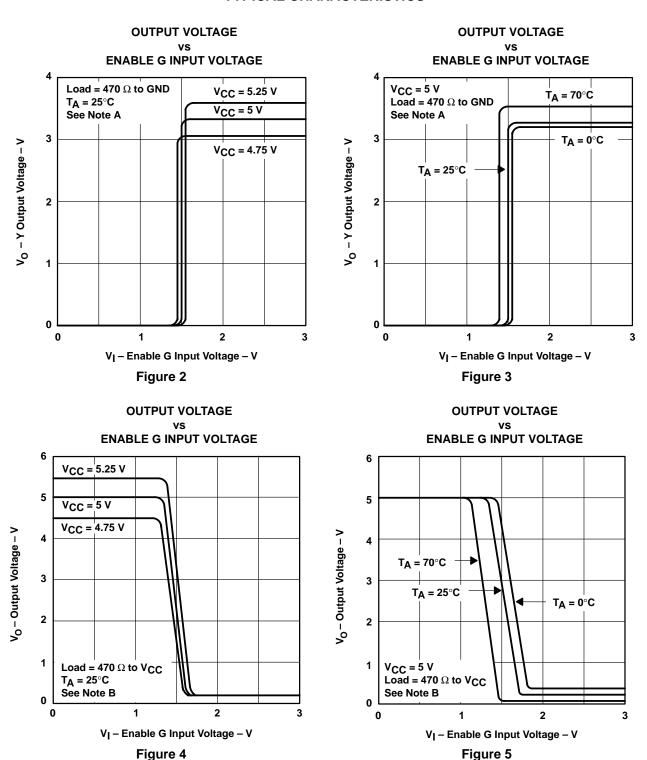
NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_O ≈ 50 Ω, t_f ≤ 15 ns, t_f ≤ 6 ns.
- C. When measuring propagation delay times and skew, switches S1 and S2 are open.
- D. Each enable is tested separately.
- E. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

Figure 1. Test Circuit and Voltage Waveforms

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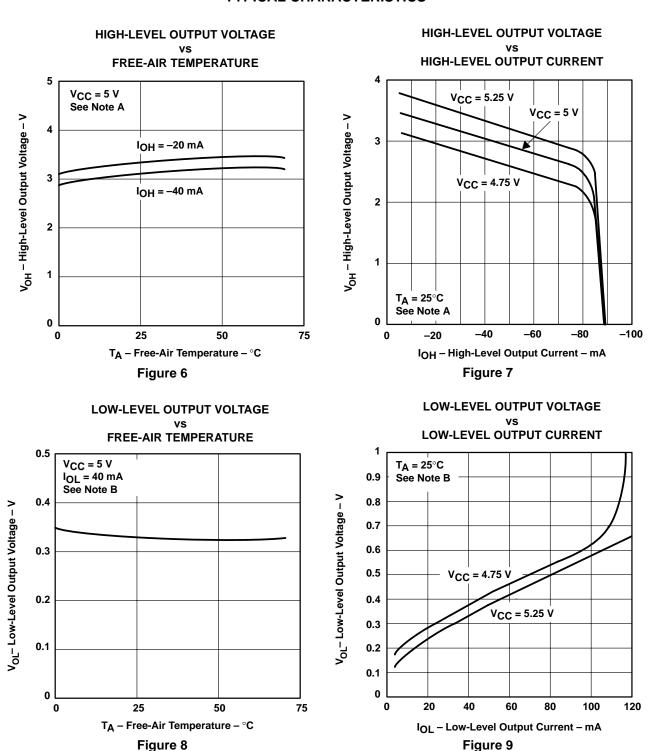
TYPICAL CHARACTERISTICS



NOTES: A. The A input is connected to V_{CC} during testing of the Y outputs and to ground during testing of the Z outputs. B. The A input is connected to ground during testing of the Y outputs and to V_{CC} during testing of the Z outputs.



TYPICAL CHARACTERISTICS



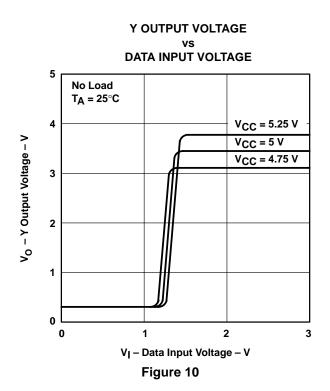
NOTES: A. The A input is connected to V_{CC} during testing of the Y outputs and to ground during testing of the Z outputs.

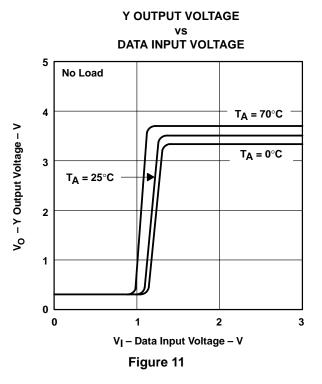
B. The A input is connected to ground during testing of the Y outputs and to V_{CC} during testing of the Z inputs.

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TYPICAL CHARACTERISTICS





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